

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	HE-YI CHENG	06/10/2020
	YU-CHIEH KUO	06/12/2020
	SHANG-JIE WU	06/10/2020
	CHE-CHIA CHANG	06/10/2020
	YI-FAN CHEN	06/12/2020
	YI-JUNG CHEN	06/10/2020
	YU-HSUN CHIU	06/10/2020
	MEI-YI LI	06/10/2020
	HSIN-CHUN HUANG	06/10/2020
RECEIVING PARTY DATA		
Name:	AU OPTRONICS CORPORATION	
Street Address:	NO. 1, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK,	
City:	HSINCHU	
State/Country:	TAIWAN	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16907290
CORRESPONDENCE DATA		
Fax Number:	(949)391-4699	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	886223692800	
Email:	usa@jcipgroup.com	
Correspondent Name:	JCIPRNET	
Address Line 1:	8F-1, NO. 100, ROOSEVELT RD. SEC. 2,	
Address Line 4:	TAIPEI, TAIWAN 100404	
ATTORNEY DOCKET NUMBER:	095299-US-PA	
NAME OF SUBMITTER:	BELINDA LEE	
SIGNATURE:	/Belinda Lee/	

DATE SIGNED:	06/29/2020
Total Attachments: 4 source=095299_del-assn#page1.tif source=095299_del-assn#page2.tif source=095299_del-assn#page3.tif source=095299_del-assn#page4.tif	

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

☒ Declaration Submitted With Initial Filing

OR

☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

DISPLAY APPARATUS

As a below named inventor (hereinafter designated as the undersigned), I hereby
declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International application number

_____ Filed on _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in
the application.

The undersigned hereby acknowledge that any willful false statement made in this
declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more
than five (5) years, or both.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. Au Optronics Corporation
of No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan,
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: He-Yi Cheng Date: 2020/06/10

Legal Name of Sole or First Inventor: **He-Yi Cheng**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Yu-Chieh Kuo Date: 2020/6/12

Legal Name of Additional Joint Inventor, if any: **Yu-Chieh Kuo**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Shang-Jie Wu Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Shang-Jie Wu**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Che-Chia Chang Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Che-Chia Chang**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Yi-Fan Chen Date: 2020/06/12

Legal Name of Additional Joint Inventor, if any: **Yi-Fan Chen**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Yi-Jung Chen Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Yi-Jung Chen**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Yu-Hsun Chiu Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Yu-Hsun Chiu**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Mei-Yi Li Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Mei-Yi Li**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Signature: Hsin-Chun Huang Date: 2020/06/10

Legal Name of Additional Joint Inventor, if any: **Hsin-Chun Huang**

Residence: Hsinchu, Taiwan

Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.